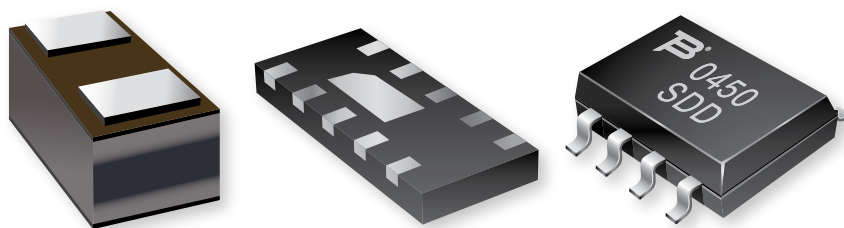




PRODUCT UPDATE MEMO

SEMICONDUCTOR COMPONENTS



Select Bourns® Semiconductor Components *Change to Country of Origin*

Riverside, California – September 24, 2024 - As part of Bourns' standardization of its process for determining the Country Of Origin ("COO") for Bourns® Semiconductor Components assembled in a different country than where the silicon wafer is fabricated or doped, Bourns is updating the COO for the part numbers provided below.

This change is being made based on Bourns' determination that the wafer fabrication process should be given greater weight than the manufacturing process steps that take place in the country of assembly for purposes of determining the applicable COO for Bourns® Semiconductor products.

Accordingly, the COO for Bourns part numbers listed below will change as of November 1, 2024 on all labels and documentation as follows:

Part Number	COO until October 31, 2024	COO as of November 1, 2024
CD0201-T05C	CN	TW
CD0201-T2.0LC	CN	TW
CD0201-T20C	CN	TW
CD0201-T3.3C	CN	TW
CD143A-SR05LC	CN	TW
CD143A-SR2.8	CN	TW
CD143A-SR3.3	CN	TW
CD143A-SR3.3C	CN	TW
CDDFN10-0506N	CN	TW
CDDFN10-0516P	CN	TW
CDDFN10-0524P	CN	TW
CDDFN10-2574N	CN	TW
CDDFN10-3304NA	CN	TW
CDDFN10-3324P	CN	TW

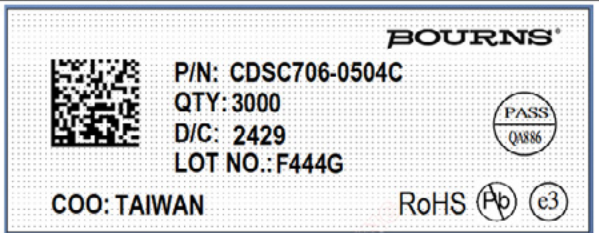
ESD2425

CDDFN10-3324P-13	CN	TW
CDDFN1610-T16S	CN	TW
CDDFN1610-T16S2	CN	TW
CDDFN2-3361P	CN	TW
CDDFN2-T05SC	CN	TW
CDDFN2-T3.3B	CN	TW
CDDFN2-T5.0LC	CN	TW
CDDFN2-T5.5LC	CN	TW
CDDFN6-0504P	CN	TW
CDDFN6-3312P	CN	TW
CDNBS08-SLVU2.8-4	CN	TW
CDNBS08-SLVU2.8-4C	CN	TW
CDSC706-0504C	CN	TW
CDSOD523-T05	CN	TW
CDSOT23-0502B	CN	TW
CDSOT23-0502U	CN	TW
CDSOT236-0502	CN	TW
CDSOT236-0504C	CN	TW
CDSOT236-0504LC	CN	TW

There are no changes to the form, fit, function, quality or reliability of the Bourns[®] Semiconductor products. There has been no change to the actual place of wafer fabrication nor to the place of final assembly.

This update will only affect the COO printed on new label and shipping paperwork on November 1, 2024 and after, for each of the affected part numbers shown in the table above.

Below, please find an example of how the label will change to clearly show country of origin as "COO Taiwan" and place of final assembly as "Assembled in China."

Until Oct.31, 2024	After Nov.1, 2024
	

Bourns will make the COO certificate available on request. Bourns will not make any changes to the labels for the Bourns[®] Semiconductor products prior to November 1, 2024. For clarification, the COO determined prior to November 1, 2024 based on the country of the assembly shall continue to apply to Bourns part numbers listed in the table above.

If you have any questions or need additional information, please feel free to [contact Customer Service/Inside Sales](#).